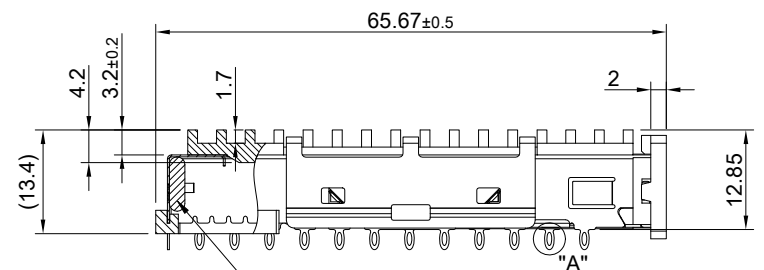
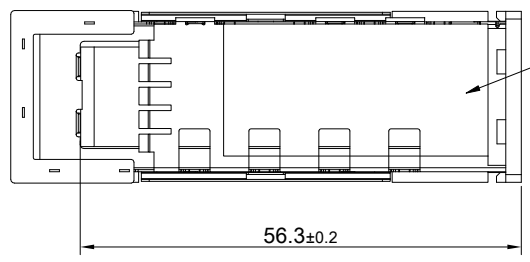
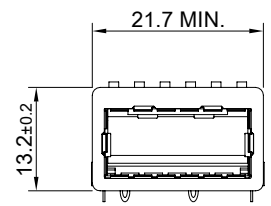


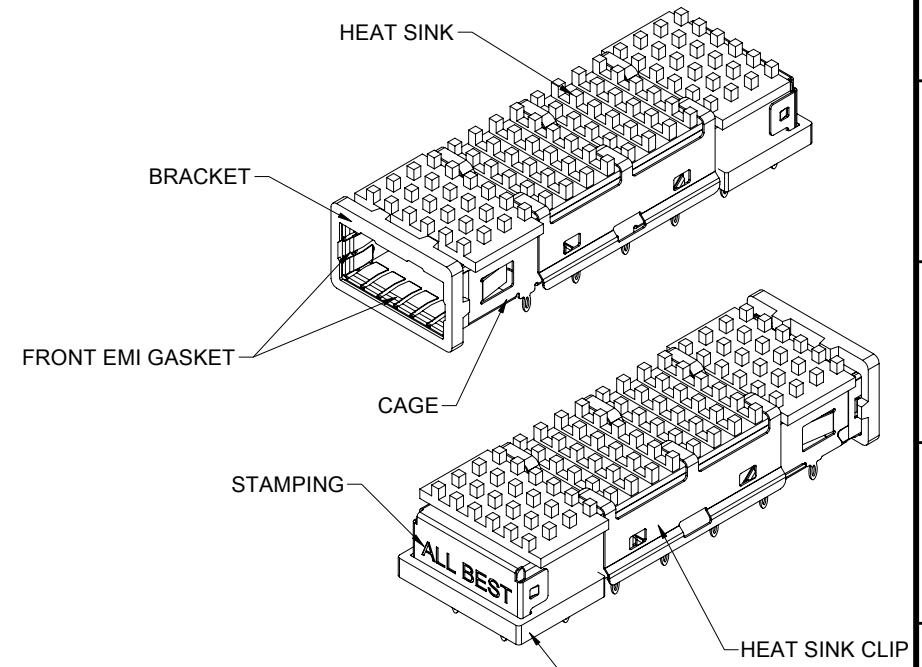
DETAIL A
SCALE 5:1



REAR EMI GASKET



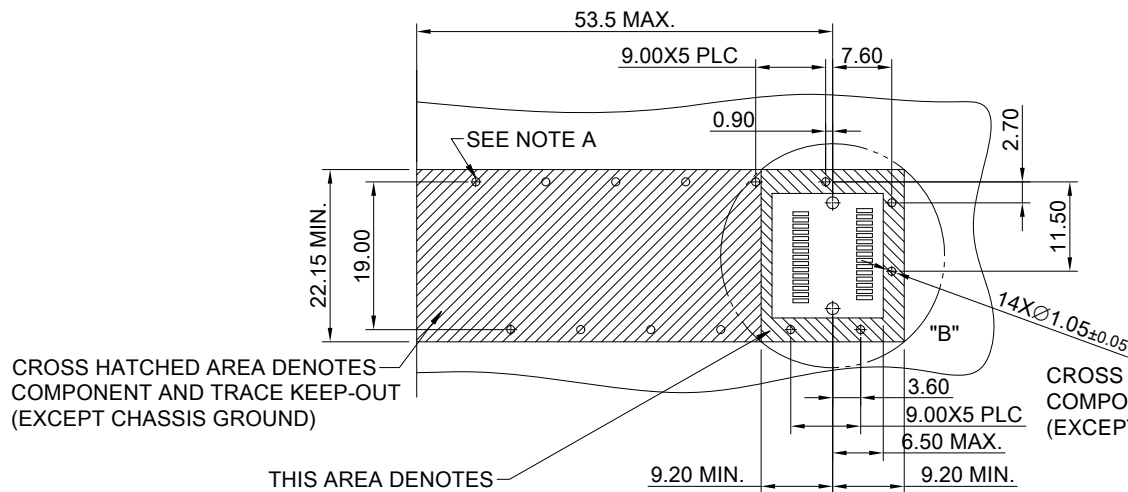
INSULATION TAPE
17mm (H)X 34mm(W) X 0.2(T)



- MATERIAL
 CAGE: NICKEL SILVER
 HEAT SINK: ALUMINUM
 HEAT SINK CLIP: STAINLESS STEEL
 FRONT EMI GASKET: COPPER ALLOY
 REAR EMI GASKET: CONDUCTIVE FOAM
 ELASTOMERIC RUBBER: NONCONDUCTIVE RUBBER (BLACK)
 BRACKET: ZINC ALLOY
 INSULATION TAPE: PET

- FINISH
 HEAT SINK: ANODE PROCESS
 FRONT EMI GASKET: TIN OVER COPPER
 BRACKET: TIN

 ALL BEST ALL BEST ELECTRONICS CO., LTD.	TITLE: XFP Cage Assembly With Heat Sink 4.2mm Tall			SHEET: 1/2		REV. B	
	DWG#: R-CG-008030-19			CHECKED: <i>Sheng Wu</i>		APPROVED: <i>George Yang</i>	
	UNIT: mm	SCALE: A4 1:1	FINISH:	MATERIAL: RoHS Compliant		DATE: 10/17/2019	
	TOLERANCE: X±0.25 .X±0.2 .XX±0.15		THIRD ANGLE PROJECTION	DRAWN: Yilu			



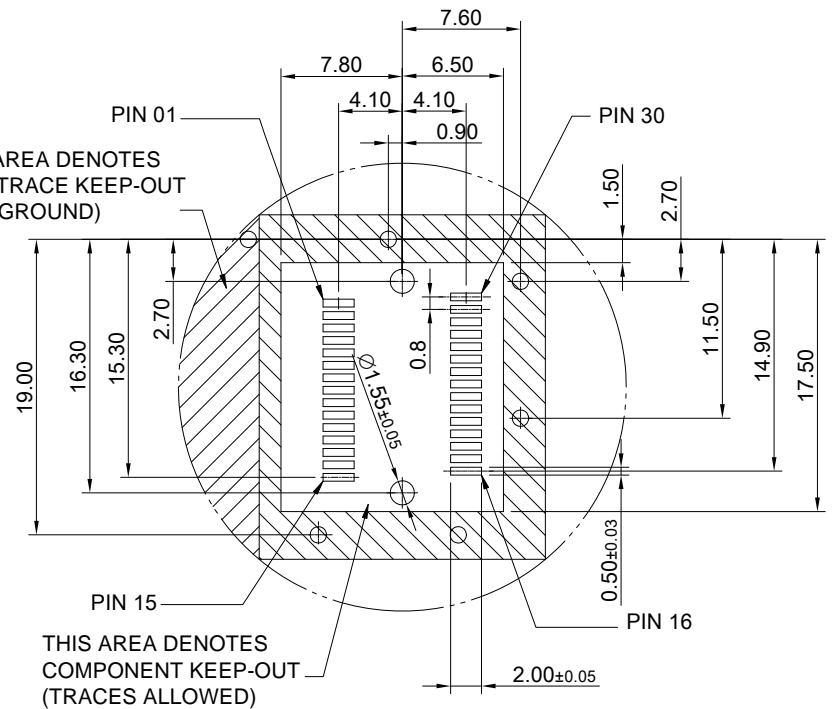
CROSS HATCHED AREA DENOTES COMPONENT AND TRACE KEEP-OUT (EXCEPT CHASSIS GROUND)

THIS AREA DENOTES COMPONENT KEEP-OUT (TRACES ALLOWED)

DETAILED HOST BOARD MECHANICAL LAYOUT
TOLERANCE: ±0.05

- NOTE A: RECOMMENDATION FOR P.C.B. HOLES
1. HOLE Ø AFTER DRILLING: 1.15±0.02
 2. HOLE Ø AFTER TIN LEAD PLATED: 1.05±0.05
 3. 25µm-50µm COPPER UNDERPLATED
 4. MAXIMUM 35µm Sn PLATING

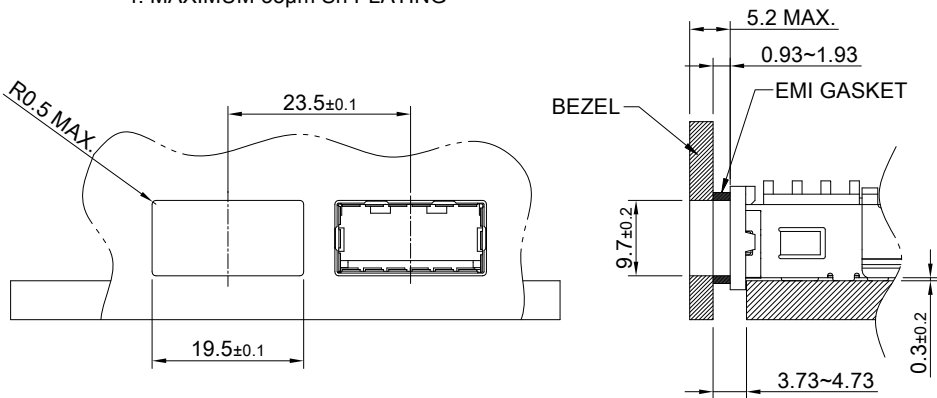
CROSS HATCHED AREA DENOTES COMPONENT AND TRACE KEEP-OUT (EXCEPT CHASSIS GROUND)



THIS AREA DENOTES COMPONENT KEEP-OUT (TRACES ALLOWED)

DETAILED HOST BOARD MECHANICAL LAYOUT
TOLERANCE: ±0.05

DETAIL B
SCALE 2:1



TITLE: XFP Cage Assembly With Heat Sink 4.2mm Tall			
DWG#: R-CG-008030-19		SHEET: 2/2	REV. B
UNIT: mm	SCALE: A4 1:1	FINISH:	CHECKED: Sheng Wu
THIRD ANGLE PROJECTION		MATERIAL: RoHS Compliant	APPROVED: George Yang
TOLERANCE: Angle: ±1° X ± 0.15 .X ± 0.1 .XX ± 0.05		DRAWN: Yilu	DATE: 10/17/2019